

Quad Precision, High Speed Operational Amplifier

OP467

FEATURES

High slew rate: 170 V/μs Wide bandwidth: 28 MHz

Fast settling time: <200 ns to 0.01%

Low offset voltage: <500 µV

Unity-gain stable

Low voltage operation: ±5 V to ±15 V

Low supply current: <10 mA
Drives capacitive loads

APPLICATIONS

High speed image display drivers High frequency active filters Fast instrumentation amplifiers High speed detectors Integrators Photo diode preamps

GENERAL DESCRIPTION

The OP467 is a quad, high speed, precision operational amplifier. It offers the performance of a high speed op amp combined with the advantages of a precision op amp in a single package. The OP467 is an ideal choice for applications where, traditionally, more than one op amp was used to achieve this level of speed and precision.

The internal compensation of the OP467 ensures stable unity-gain operation, and it can drive large capacitive loads without oscillation. With a gain bandwidth product of 28 MHz driving a 30 pF load, output slew rate is 170 V/ μ s, and settling time to 0.01% in less than 200 ns, the OP467 provides excellent dynamic accuracy in high speed data acquisition systems. The channel-to-channel separation is typically 60 dB at 10 MHz.

The dc performance of the OP467 includes less than 0.5 mV of offset, a voltage noise density below 6 nV/ $\sqrt{\text{Hz}}$, and a total supply current under 10 mA. The common-mode rejection ratio (CMRR) is typically 85 dB. The power supply rejection ratio (PSRR) is typically 107 dB. PSRR is maintained to better than 40 dB with input frequencies as high as 1 MHz. The low offset and drift plus high speed and low noise make the OP467 usable in applications such as high speed detectors and instrumentation.

The OP467 is specified for operation from ± 5 V to ± 15 V over the extended industrial temperature range (-40° C to $+85^{\circ}$ C) and is available in a 14-lead PDIP, a 14-lead CERDIP, a 16-lead SOIC, and a 20-terminal LCC.

Contact your local sales office for the MIL-STD-883 data sheet and availability.

Rev.

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PIN CONFIGURATIONS

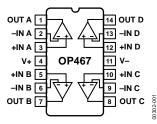


Figure 1. 14-Lead CERDIP (Y Suffix) and 14-Lead PDIP (P Suffix)

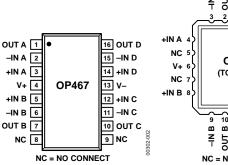


Figure 2. 16-Lead SOIC (S Suffix)

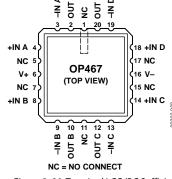


Figure 3. 20-Terminal LCC (RC Suffix)

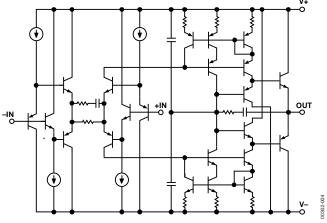


Figure 4. Simplified Schematic

OP467* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS \Box

View a parametric search of comparable parts.

DOCUMENTATION

Application Notes

- AN-402: Replacing Output Clamping Op Amps with Input Clamping Amps
- AN-414: Low Cost, Low Power Devices for HDSL Applications
- AN-417: Fast Rail-to-Rail Operational Amplifiers Ease Design Constraints in Low Voltage High Speed Systems
- AN-581: Biasing and Decoupling Op Amps in Single Supply Applications

Data Sheet

- · OP467: Military Data Sheet
- OP467: Quad Precision, High Speed Operational Amplifier Data Sheet

TOOLS AND SIMULATIONS \Box

- · Analog Filter Wizard
- · Analog Photodiode Wizard
- · Power Dissipation vs Die Temp
- VRMS/dBm/dBu/dBV calculators
- OP467 SPICE Macro-Model

REFERENCE MATERIALS 🖵

Tutorials

- MT-032: Ideal Voltage Feedback (VFB) Op Amp
- MT-033: Voltage Feedback Op Amp Gain and Bandwidth
- MT-047: Op Amp Noise
- MT-048: Op Amp Noise Relationships: 1/f Noise, RMS Noise, and Equivalent Noise Bandwidth
- MT-049: Op Amp Total Output Noise Calculations for Single-Pole System
- MT-050: Op Amp Total Output Noise Calculations for Second-Order System
- MT-052: Op Amp Noise Figure: Don't Be Misled
- MT-053: Op Amp Distortion: HD, THD, THD + N, IMD, SFDR, MTPR
- MT-056: High Speed Voltage Feedback Op Amps
- MT-058: Effects of Feedback Capacitance on VFB and CFB Op Amps
- MT-059: Compensating for the Effects of Input Capacitance on VFB and CFB Op Amps Used in Current-to-Voltage Converters
- MT-060: Choosing Between Voltage Feedback and Current Feedback Op Amps

DESIGN RESOURCES 🖵

- OP467 Material Declaration
- · PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all OP467 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT 🖵

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK 🖵

Submit feedback for this data sheet.

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SPECIFICATIONS

ELECTRICAL CHARACTERISTICS

@ $V_s = \pm 15.0$ V, $T_A = 25$ °C, unless otherwise noted.

Table 1.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	Vos			0.2	0.5	mV
		$-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +85^{\circ}\text{C}$			1	mV
Input Bias Current	I _B	$V_{CM} = 0 V$		150	600	nA
		$V_{CM} = 0 \text{ V}, -40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$		150	700	nA
Input Offset Current	los	$V_{CM} = 0 V$		10	100	nA
		$V_{CM} = 0 \text{ V}, -40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$		10	150	nA
Common-Mode Rejection	CMR	$V_{CM} = \pm 12 V$	80	90		dB
	CMR	$V_{CM} = \pm 12 \text{ V}, -40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$	80	88		dB
Large Signal Voltage Gain	Avo	$R_L = 2 k\Omega$	83	86		dB
		$R_L = 2 \text{ k}\Omega$, $-40^{\circ}\text{C} \le T_A \le +85^{\circ}\text{C}$	77.5			dB
Offset Voltage Drift	$\Delta V_{OS}/\Delta T$			3.5		μV/°C
Bias Current Drift	ΔΙ _Β /ΔΤ			0.2		pA/°C
Long-Term Offset Voltage Drift ¹	$\Delta V_{OS}/\Delta T$				750	μV
OUTPUT CHARACTERISTICS						
Output Voltage Swing	Vo	$R_L = 2 k\Omega$	±13.0	±13.5		V
, 3 3		$R_L = 2 \text{ k}\Omega$, $-40^{\circ}\text{C} \le T_A \le +85^{\circ}\text{C}$	±12.9	±13.12		V
POWER SUPPLY		·				
Power Supply Rejection Ratio	PSRR	$\pm 4.5 \text{ V} \le \text{V}_{\text{S}} \le \pm 18 \text{ V}$	96	120		dB
r ower supply negection natio	1 31	$-40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$	86	115		dB
Supply Current	I _{SY}	V ₀ = 0 V		8	10	mA
Juppi, Carrein	1.51	$V_0 = 0 \text{ V}, -40^{\circ}\text{C} \le T_A \le +85^{\circ}\text{C}$		· ·	13	mA
Supply Voltage Range	Vs	10 0 1, 10 0 2 1, 2 1 0 0	±4.5		±18	V
DYNAMIC PERFORMANCE						
Gain Bandwidth Product	GBP	$A_V = +1, C_L = 30 \text{ pF}$		28		MHz
Slew Rate	SR	$V_{IN} = 10 \text{ V step, R}_L = 2 \text{ k}\Omega, C_L = 30 \text{ pF}$		20		141112
Siew nate	311	$A_V = +1$	125	170		V/µs
		$A_V = -1$	1.23	350		V/µs
Full-Power Bandwidth	BWo	$V_{IN} = 10 \text{ V step}$		2.7		MHz
Settling Time	t _s	To 0.01%, $V_{IN} = 10 \text{ V step}$		200		ns
Phase Margin	θ_0	10 0.0170, VIN - 10 V Step		45		Degrees
Input Capacitance	00			15		Degrees
Common Mode				2.0		pF
Differential				1.0		pF
NOISE PERFORMANCE				1.0		Pi
		f 0111-t-1011-		0.15		
Voltage Noise	e _N p-p	f = 0.1 Hz to 10 Hz		0.15		μV p-p
Voltage Noise Density	e _N	f = 1 kHz		6		nV/√Hz
Current Noise Density	i _N	f = 1 kHz		0.8		pA/√Hz

¹ Long-term offset voltage drift is guaranteed by 1000 hrs. Life test performed on three independent wafer lots at 125°C, with an LTPD of 1.3.

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@ $V_S = \pm 5.0$ V, $T_A = 25$ °C, unless otherwise noted.

Table 2.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	Vos			0.3	0.5	mV
		$-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +85^{\circ}\text{C}$			1	mV
Input Bias Current	I _B	$V_{CM} = 0 V$		125	600	nA
		$V_{CM} = 0 \text{ V}, -40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$		150	700	nA
Input Offset Current	los	$V_{CM} = 0 V$		20	100	nA
		$V_{CM} = 0 \text{ V}, -40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$			150	nA
Common-Mode Rejection	CMR	$V_{CM} = \pm 2.0 \text{ V}$	76	85		dB
	CMR	$V_{CM} = \pm 2.0 \text{ V}, -40^{\circ}\text{C} \le T_{A} \le +85^{\circ}\text{C}$	76	80		dB
Large Signal Voltage Gain	Avo	$R_L = 2 k\Omega$	80	83		dB
		$R_L = 2 \text{ k}\Omega$, $-40^{\circ}\text{C} \le T_A \le +85^{\circ}\text{C}$	74			dB
Offset Voltage Drift	ΔV _{OS} /ΔT			3.5		μV/°C
Bias Current Drift	$\Delta I_B/\Delta T$			0.2		pA/°C
OUTPUT CHARACTERISTICS						
Output Voltage Swing	Vo	$R_L = 2 k\Omega$	±3.0	±3.5		V
		$R_L = 2 \text{ k}\Omega$, $-40^{\circ}\text{C} \le T_A \le +85^{\circ}\text{C}$	±3.0	±3.20		V
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	$\pm 4.5 \text{ V} \le \text{V}_{\text{S}} \le \pm 5.5 \text{ V}$	92	107		dB
		-40 °C $\leq T_A \leq +85$ °C	83	105		dB
Supply Current	Isy	$V_O = 0 V$		8	10	mA
		$V_0 = 0 \text{ V}, -40^{\circ}\text{C} \le T_A \le +85^{\circ}\text{C}$			12	mA
DYNAMIC PERFORMANCE						
Gain Bandwidth Product	GBP	$A_V = +1$		22		MHz
Slew Rate	SR	$V_{IN} = 5 \text{ V step, } R_L = 2 \text{ k}\Omega, C_L = 39 \text{ pF}$				
		$A_V = +1$		90		V/µs
		$A_V = -1$		90		V/µs
Full-Power Bandwidth	BW _ρ	$V_{IN} = 5 V step$		2.5		MHz
Settling Time	ts	To 0.01%, V _{IN} = 5 V step		280		ns
Phase Margin	θ_0			45		Degrees
NOISE PERFORMANCE						
Voltage Noise	e _N p-p	f = 0.1 Hz to 10 Hz		0.15		μV р-р
Voltage Noise Density	e _N	f = 1 kHz		7		nV/√Hz
Current Noise Density	i _N	f = 1 kHz		0.8		pA/√Hz

WAFER TEST LIMITS¹

@ $V_S = \pm 15.0$ V, $T_A = 25$ °C, unless otherwise noted.

Table 3.

Parameter	Symbol	Conditions	Limit	Unit
Offset Voltage	Vos		±0.5	mV max
Input Bias Current	I_B	$V_{CM} = 0 V$	600	nA max
Input Offset Current	los	$V_{CM} = 0 V$	100	nA max
Input Voltage Range ²			±12	V min/max
Common-Mode Rejection Ratio	CMRR	$V_{CM} = \pm 12 V$	80	dB min
Power Supply Rejection Ratio	PSRR	$V = \pm 4.5 \text{ V to } \pm 18 \text{ V}$	96	dB min
Large Signal Voltage Gain	Avo	$R_L = 2 k\Omega$	83	dB min
Output Voltage Range	Vo	$R_L = 2 k\Omega$	±13.0	V min
Supply Current	I _{SY}	$V_0 = 0 V, R_L = \infty$	10	mA max

¹ Electrical tests and wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult sales to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.
² Guaranteed by CMR test.

ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter ¹	Rating
Supply Voltage	±18 V
Input Voltage ²	±18 V
Differential Input Voltage ²	±26 V
Output Short-Circuit Duration	Limited
Storage Temperature Range	
14-Lead CERDIP and 20-Terminal LCC	−65°C to +175°C
14-Lead PDIP and 16-Lead SOIC	−65°C to +150°C
Operating Temperature Range	
OP467A	−55°C to +125°C
OP467G	-40°C to +85°C
Junction Temperature Range	
14-Lead CERDIP and 20-Terminal LCC	−65°C to +175°C
14-Lead PDIP and 16-Lead SOIC	−65°C to +150°C
Lead Temperature (Soldering, 60 sec)	300°C

¹ Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 5.

Package Type	θ_{JA}^1	Ө лс	Unit
14-Lead CERDIP (Y)	94	10	°C/W
14-Lead PDIP (P)	76	33	°C/W
16-Lead SOIC (S)	88	23	°C/W
20-Terminal LCC (RC)	78	33	°C/W

 $^{^1\}theta_{JA}$ is specified for the worst-case conditions, that is, θ_{JA} is specified for device in socket for CERDIP, PDIP, and LCC packages, and θ_{JA} is specified for device soldered in circuit board for the SOIC package.

DICE CHARACTERISTICS

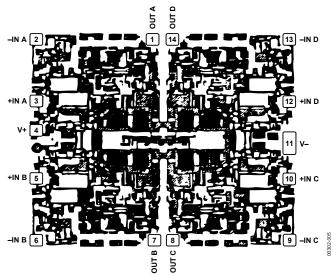


Figure 5. 0.111 Inch × 0.100 Inch DIE Size, 11,100 sq. mils, Substrate Connected to V+, 165 Transistors

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

 $^{^2}$ For supply voltages less than ± 18 V, the absolute maximum input voltage is equal to the supply voltage.

TYPICAL PERFORMANCE CHARACTERISTICS

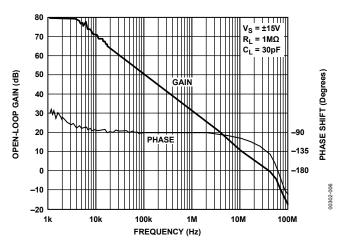


Figure 6. Open-Loop Gain, Phase vs. Frequency

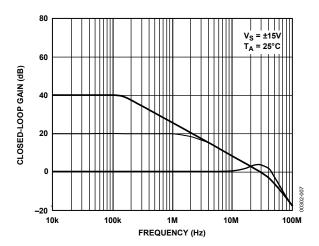


Figure 7. Closed-Loop Gain vs. Frequency

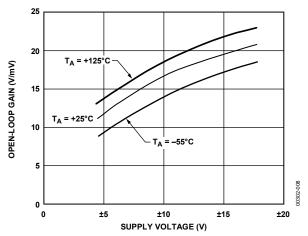


Figure 8. Open-Loop Gain vs. Supply Voltage

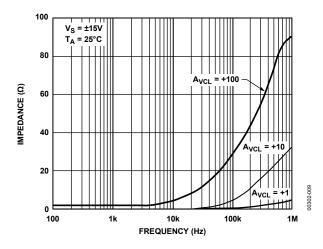


Figure 9. Closed-Loop Output Impedance vs. Frequency

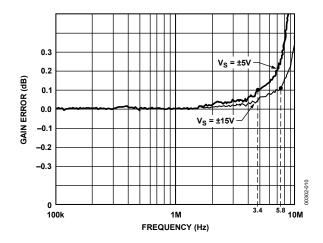


Figure 10. Gain Error vs. Frequency

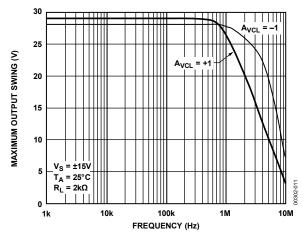


Figure 11. Maximum V_{OUT} Swing vs. Frequency

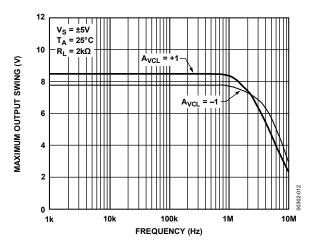


Figure 12. Maximum V_{OUT} Swing vs. Frequency

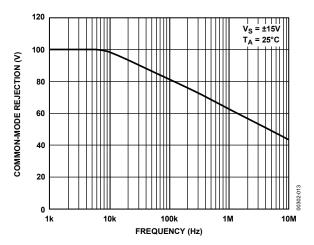


Figure 13. Common-Mode Rejection vs. Frequency

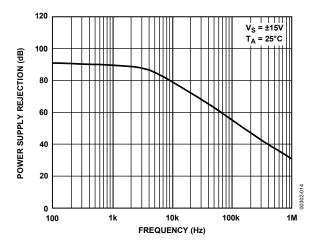


Figure 14. Power-Supply Rejection vs. Frequency

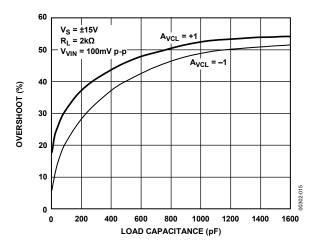


Figure 15. Small Signal Overshoot vs. Load Capacitance

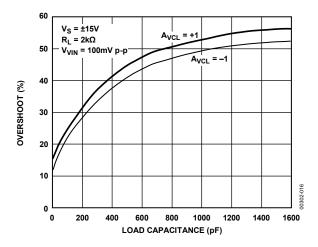


Figure 16. Small Signal Overshoot vs. Load Capacitance

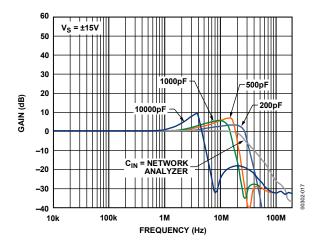


Figure 17. Noninverting Gain vs. Capacitive Loads

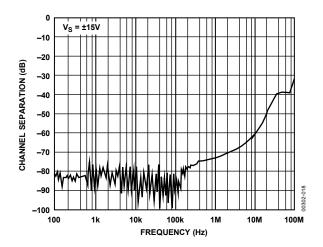


Figure 18. Channel Separation vs. Frequency

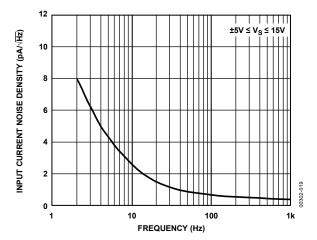


Figure 19. Input Current Noise Density vs. Frequency

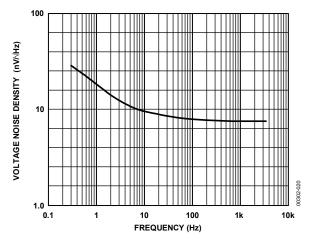


Figure 20. Voltage Noise Density vs. Frequency

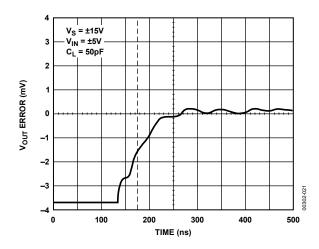


Figure 21. Settling Time, Negative Edge

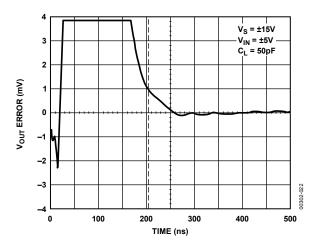


Figure 22. Settling Time, Positive Edge

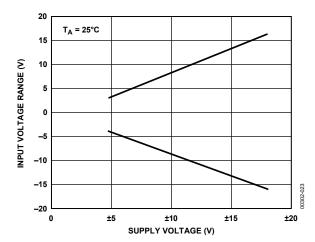


Figure 23. Input Voltage Range vs. Supply Voltage

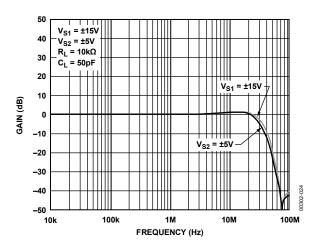


Figure 24. Noninverting Gain vs. Supply Voltage

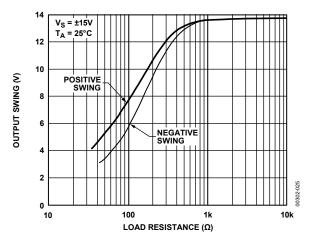


Figure 25. Output Swing vs. Load Resistance

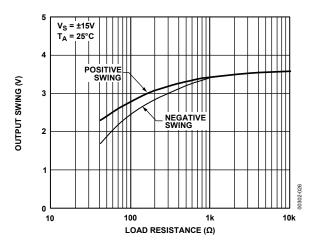


Figure 26. Output Swing vs. Load Resistance

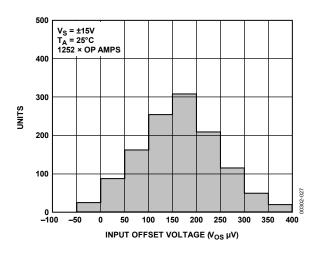


Figure 27. Input Offset Voltage Distribution

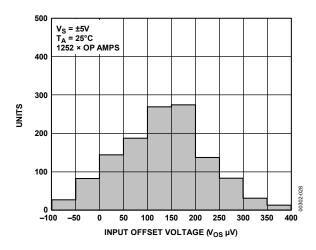


Figure 28. Input Offset Voltage Distribution

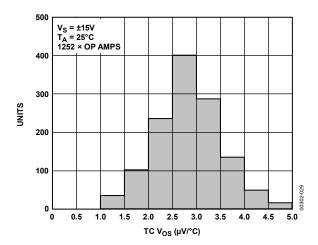


Figure 29. TC Vos Distribution

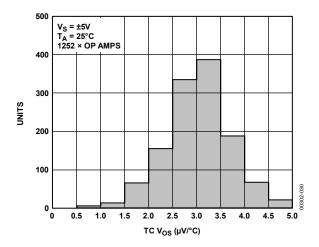


Figure 30. TC Vos Distribution

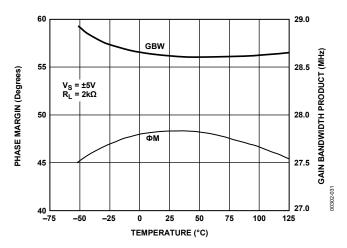


Figure 31. Phase Margin and Gain Bandwidth vs. Temperature

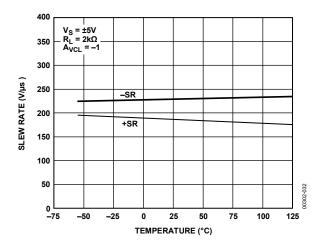


Figure 32. Slew Rate vs. Temperature

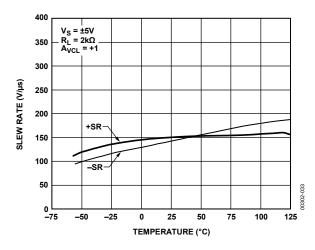


Figure 33. Slew Rate vs. Temperature

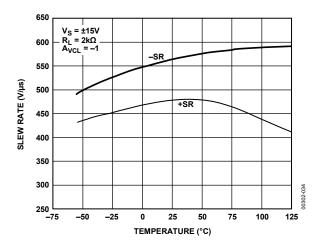


Figure 34. Slew Rate vs. Temperature

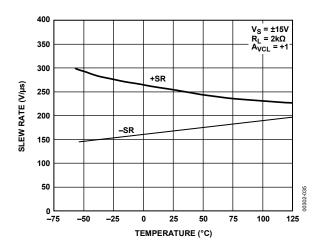


Figure 35. Slew Rate vs. Temperature

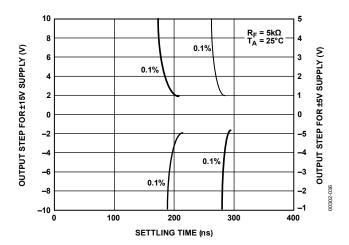


Figure 36. Output Step vs. Settling Time

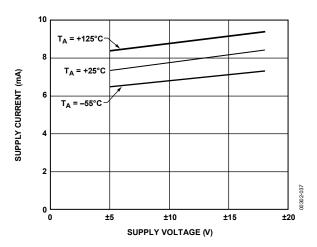


Figure 37. Supply Current vs. Supply Voltage

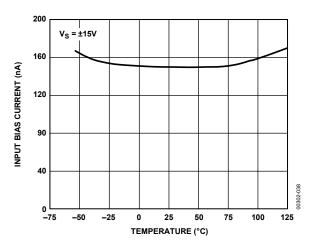


Figure 38. Input Bias Current vs. Temperature

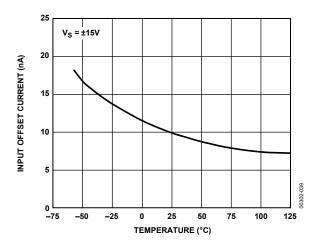


Figure 39. Input Offset Current vs. Temperature

APPLICATIONS INFORMATION OUTPUT SHORT-CIRCUIT PERFORMANCE

To achieve a wide bandwidth and high slew rate, the OP467 output is not short-circuit protected. Shorting the output to ground or to the supplies may destroy the device.

For safe operation, the output load current should be limited so that the junction temperature does not exceed the absolute maximum junction temperature.

The maximum internal power dissipation can be calculated by

$$P_D = \frac{T_J \max - T_A}{\theta_{JA}}$$

where:

 T_I and T_A are junction and ambient temperatures, respectively. P_D is device internal power dissipation.

 θ_{JA} is the packaged device thermal resistance given in the data sheet.

UNUSED AMPLIFIERS

It is recommended that any unused amplifiers in the quad package be connected as a unity-gain follower with a 1 $k\Omega$ feedback resistor with noninverting input tied to the ground plain.

PCB LAYOUT CONSIDERATIONS

Satisfactory performance of a high speed op amp largely depends on a good PCB layout. To achieve the best dynamic performance, follow the high frequency layout technique.

GROUNDING

A good ground plain is essential to achieve the optimum performance in high speed applications. It can significantly reduce the undesirable effects of ground loops and IR drops by providing a low impedance reference point. Best results are obtained with a multilayer board design with one layer assigned to the ground plain. To maintain a continuous and low impedance ground, avoid running any traces on this layer.

POWER SUPPLY CONSIDERATIONS

In high frequency circuits, device lead length introduces an inductance in series with the circuit. This inductance, combined with stray capacitance, forms a high frequency resonance circuit. Poles generated by these circuits cause gain peaking and additional phase shift, reducing the phase margin of the op amp and leading to an unstable operation.

A practical solution to this problem is to reduce the resonance frequency low enough to take advantage of the power supply rejection of the amplifier. This is easily done by placing capacitors across the supply line and the ground plane as close as possible to the device pin. Because capacitors also have internal parasitic components, such as stray inductance, selecting the right capacitor is important. To be effective, they should have low impedance over the frequency range of interest. Tantalum capacitors are an excellent choice for their high capacitance/size ratio, but their effective series resistance (ESR) increases with frequency making them less effective.

On the other hand, ceramic chip capacitors have excellent ESR and effective series inductance (ESL) performance at higher frequencies, and because of their small size, they can be placed very close to the device pin, further reducing the stray inductance. Best results are achieved by using a combination of these two capacitors. A 5 μF to 10 μF tantalum parallel capacitor with a 0.1 μF ceramic chip capacitor is recommended. If additional isolation from high frequency resonances of the power supply is needed, a ferrite bead should be placed in series with the supply lines between the bypass capacitors and the power supply. Note that addition of the ferrite bead introduces a new pole and zero to the frequency response of the circuit and could cause unstable operation if it is not selected properly.

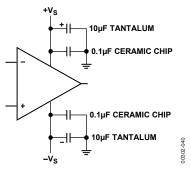


Figure 40. Recommended Power Supply Bypass

SIGNAL CONSIDERATIONS

Input and output traces need special attention to assure a minimum stray capacitance. Input nodes are very sensitive to capacitive reactance, particularly when connected to a high impedance circuit. Stray capacitance can inject undesirable signals from a noisy line into a high impedance input. Protect high impedance input traces by providing guard traces around them, which also improves the channel separation significantly.

Additionally, any stray capacitance in parallel with the input capacitance of the op amp generates a pole in the frequency response of the circuit. The additional phase shift caused by this pole reduces the gain margin of the circuit. If this pole is within the gain range of the op amp, it causes unstable performance. To reduce these undesirable effects, use the lowest impedance where possible. Lowering the impedance at this node places the poles at a higher frequency, far above the gain range of the amplifier. Stray capacitance on the PCB can be reduced by making the traces narrow and as short as possible. Further reduction can be realized by choosing a smaller pad size, increasing the spacing between the traces, and using PCB material with a low dielectric constant insulator (dielectric constant of some common insulators: air = 1, Teflon* = 2.2, and FR4 = 4.7, with air being an ideal insulator).

Removing segments of the ground plane directly under the input and output pads is recommended.

0P467

Outputs of high speed amplifiers are very sensitive to capacitive loads. A capacitive load introduces a pair of pole and zero to the frequency response of the circuit, reducing the phase margin, leading to unstable operation or oscillation.

Generally, it is good design practice to isolate the output of the amplifier from any capacitive load by placing a resistor between the output of the amplifier and the rest of the circuits. A series resistor of 10 Ω to 100 Ω is normally sufficient to isolate the output from a capacitive load.

The OP467 is internally compensated to provide stable operation and is capable of driving large capacitive loads without oscillation.

Sockets are not recommended because they increase the lead inductance/capacitance and reduce the power dissipation of the package by increasing the thermal resistance of the leads. If sockets must be used, use Teflon or pin sockets with the shortest possible leads.

PHASE REVERSAL

The OP467 is immune to phase reversal; its inputs can exceed the supply rails by a diode drop without any phase reversal.

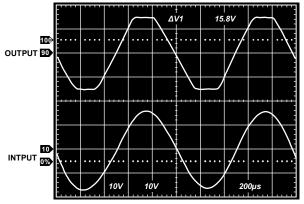


Figure 41. No Phase Reversal $(A_V = +1)$

SATURATION RECOVERY TIME

The OP467 has a fast and symmetrical recovery time from either rail. This feature is very useful in applications such as high speed instrumentation and measurement circuits, where the amplifier is frequently exposed to large signals that overload the amplifier.

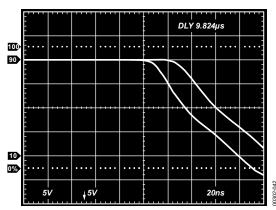


Figure 42. Saturation Recovery Time, Positive Rail

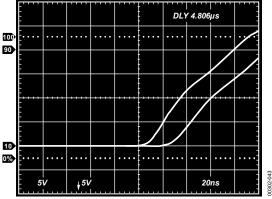


Figure 43. Saturation Recovery Time, Negative Rail

HIGH SPEED INSTRUMENTATION AMPLIFIER

The OP467 performance lends itself to a variety of high speed applications, including high speed precision instrumentation amplifiers. Figure 44 represents a circuit commonly used for data acquisition, CCD imaging, and other high speed applications.

The circuit gain is set by $R_{G}.\ A\ 2\ k\Omega$ resistor sets the circuit gain to 2; for unity gain, remove $R_{G}.$ For any other gain settings, use the following formula

 $G = 2/R_G$ (Resistor Value is in $k\Omega$)

 R_C is used for adjusting the dc common-mode rejection, and C_C is used for ac common-mode rejection adjustments.

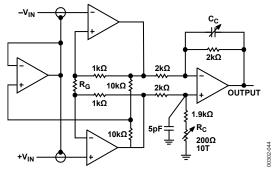


Figure 44. A High Speed Instrumentation Amplifier

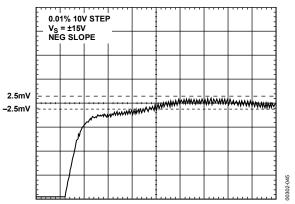


Figure 45. Instrumentation Amplifier Settling Time to 0.01% for a 10 V Step Input (Negative Slope)

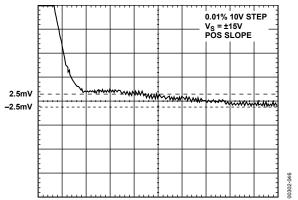


Figure 46. Instrumentation Amplifier Settling Time to 0.01% for a 10 V Step Input (Positive Slope)

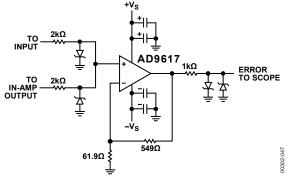


Figure 47. Settling Time Measurement Circuit

2 MHz BIQUAD BAND-PASS FILTER

The circuit in Figure 48 is commonly used in medical imaging ultrasound receivers. The 30 MHz bandwidth is sufficient to accurately produce the 2 MHz center frequency, as the measured response shows in Figure 49. When the bandwidth of the op amp is too close to the center frequency of the filter, the internal phase shift of the amplifier causes excess phase shift at 2 MHz, which alters the response of the filter. In fact, if the chosen op amp has a bandwidth close to 2 MHz, the combined phase shift of the three op amps causes the loop to oscillate.

Careful consideration must be given to the layout of this circuit as with any other high speed circuit.

If the phase shift introduced by the layout is large enough, it can alter the circuit performance, or worse, cause oscillation.

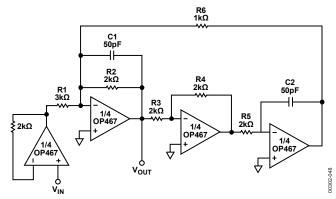


Figure 48. 2 MHz Biquad Filter

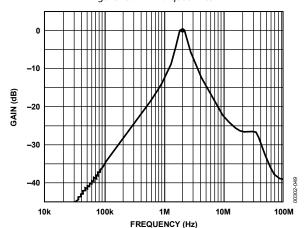


Figure 49. Biquad Filter Response

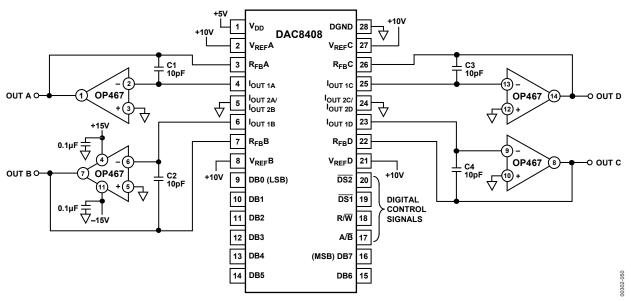


Figure 50. Quad DAC Unipolar Operation

FAST I-TO-V CONVERTER

The fast slew rate and fast settling time of the OP467 are well suited to the fast buffers and I-to-V converters used in a variety of applications. The circuit in Figure 50 is a unipolar quad DAC consisting of only two ICs. The current output of the DAC8408 is converted to a voltage by the OP467 configured as an I-to-V converter. This circuit is capable of settling to 0.1% within 200 ns. Figure 51 and Figure 52 show the full-scale settling time of the outputs. To obtain reliable circuit performance, keep the traces from the $I_{\rm OUT}$ of the DAC to the inverting inputs of the OP467 short to minimize parasitic capacitance.

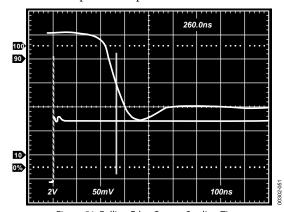


Figure 51. Falling Edge Output Settling Time

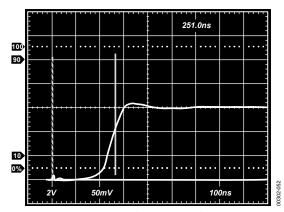


Figure 52. Rising Edge Output Settling Time

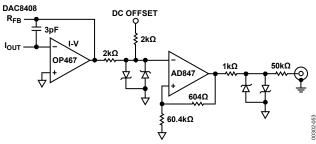


Figure 53. DAC Vout Settling Time Circuit

OP467 SPICE MARCO-MODEL

```
* Node assignments
                    noninverting input
                                                                     * COMMON-MODE STAGE WITH ZERO AT 1.26 kHz
                          inverting input
                                                                     ECM
                                                                             13
                                                                                   98
                                                                                           POLY (2) (1, 20)
                                                                                                                (2,20) 0 0. 5 0 . 5
                                 positive supply
                                                                     R8
                                                                             13
                                                                                   14
                                                                                           1E6
                                        negative supply
                                                                     R9
                                                                             14
                                                                                   98
                                                                                           25.119
                                               output
                                                                                           126.721E-12
                                                                     C3
                                                                             13
                                                                                   14
. SUBCKT OP467
                          2
                                 99
                                        50
                                               27
                                                                     *POLE AT 400E6
* INPUT STAGE
                                                                     R10
                                                                             15
                                                                                    98
                                                                                           1E6
                                                                     C4
                                                                                    98
                                                                                           0.398E-15
                                                                             15
11
        4
             5
                  10E-3
                                                                     G2
                                                                             98
                                                                                    15
                                                                                           (10,20) 1E-6
             0
CIN
        1
             2
                  1E-12
                                                                     * OUTPUT STAGE
IOS
        1
             2
                  5E-9
        5
             2
Q1
                  8 QN
                                                                     ISY
                                                                             99
                                                                                    50
                                                                                           -8.183E-3
        6
             7
                  9 QN
Q2
                                                                                           96.429E3
                                                                     RMP1
                                                                             99
                                                                                    20
R3
        99
             5
                  185.681
                                                                                           96.429E3
                                                                     RMP2
                                                                             20
                                                                                    50
R4
        99
             6
                  185.681
                                                                     RO1
                                                                             99
                                                                                           200
R5
        8
             4
                  180.508
                                                                                    26
                                                                     RO<sub>2</sub>
                                                                             26
                                                                                    50
                                                                                           200
        9
             4
                  180.508
R6
                                                                     L1
                                                                                    27
                                                                                           1E-7
        7
                                                                             26
EOS
             1
                  POLY (1)
                                 (14,20)
                                           50E-6
                                                    1
                                                                     GO1
                                                                             26
                                                                                    99
                                                                                           (99,15) 5E-3
EREF
        98
             0
                  (20,0) 1
                                                                     GO<sub>2</sub>
                                                                             50
                                                                                    26
                                                                                           (15,50) 5E-3
                                                                     G4
                                                                             23
                                                                                    50
                                                                                           (15,26) 5E-3
* GAIN STAGE AND DOMINANT POLE AT 1.5 kHz
                                                                     G5
                                                                             24
                                                                                    50
                                                                                           (26,15) 5E-3
                                                                     V3
                                                                             21
                                                                                    26
                                                                                           50
R7
        10
              98
                    3.714E6
                                                                     V4
                                                                                    22
                                                                                           50
C2
        10
              98
                    28.571E-12
                                                                             26
                                                                     D3
                                                                             15
                                                                                    21
                                                                                           DX
                    (5,6) 5.386E-3
G1
        98
              10
                                                                     D4
                                                                                           DX
                                                                             22
                                                                                    15
V1
        99
              11
                    1.6
                                                                                           DX
                                                                     D5
                                                                             99
                                                                                    23
V2
        12
              50
                    1.6
                                                                                           DX
                                                                     D6
                                                                             99
                                                                                    24
D1
        10
              11
                    DX
                                                                     D7
                                                                             50
                                                                                    23
                                                                                           DΥ
D2
        12
              10
                    DX
                                                                     D8
                                                                             50
                                                                                    24
                                                                                           DY
RC
        10
              28
                    1.4E3
CC
        28
              27
                    12E-12
                                                                     * MODELS USED
                                                                     . MODEL QN NPN (BF=33.333E3)
                                                                     . MODEL DX D
                                                                     . MODEL DY D (BV=50)
```

. ENDS OP467

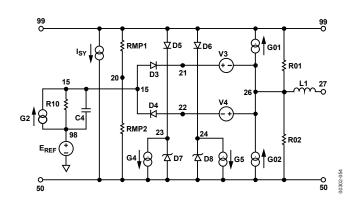


Figure 54. SPICE Macro-Model Output Stage

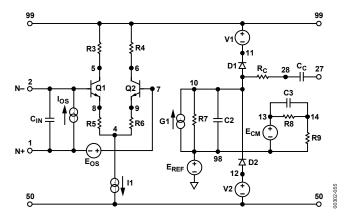
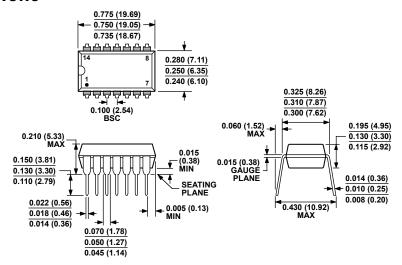


Figure 55. SPICE Macro-Model Input and Gain Stage

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-001

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

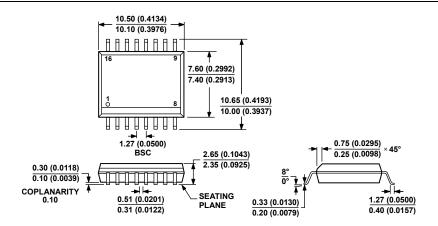
> Figure 56. 14-Lead Plastic Dual In-Line Package [PDIP] (N-14)P-Suffix Dimensions shown in inches and (millimeters)

0.005 (0.13) MIN 0.098 (2.49) MAX 0.310 (7.87) 0.220 (5.59) 0.100 (2.54) BSC 0.320 (8.13) 0.290 (7.37) 0.785 (19.94) MAX 0.060 (1.52) 0.015 (0.38) 0.200 (5.08) MAX 0.200 (5.08) Ţ (3.81) ▼ MIN 0.125 (3.18) 0.015 (0.38) SEATING PLANE 0.023 (0.58) 0.070 (1.78) 15° 0.008 (0.20) 0.014 (0.36) 0.030 (0.76)

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 57. 14-Lead Ceramic Dual In-Line Package [CERDIP] (Q-14) Y-Suffix

Dimensions shown in inches and (millimeters)



COMPLIANT TO JEDEC STANDARDS MS-013-AA CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 58. 16-Lead Standard Small Outline Package [SOIC_W] Wide Body (RW-16) S-Suffix Dimensions shown in millimeters and (inches)

0.200 (5.08) REF 0.075 (1.91) REF 0.100 (2.54) 0.100 (2.54) REF 0.064 (1.63) 0.095 (2.41) 0.015 (0.38) 0.075 (1.90) MIN **v** 0.028 (0.71) 0.358 (9.09) 0.358 (9.09) MAX 0.022 (0.56) 0.011 (0.28) BOTTOM VIEW 0.342 (8.69) 0.007 (0.18) R TYP ± 0.050 (1.27) SQ 0.075 (1.91) T 14 0.088 (2.24) 0.055 (1.40) 0.054 (1.37) 0.045 (1.14)

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 59. 20-Terminal Ceramic Leadless Chip Carrier [LCC] (E-20-1) RC-Suffix Dimensions shown in inches and (millimeters)

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option
OP467GP	−40°C to +85°C	14-Lead PDIP	N-14
OP467GPZ	−40°C to +85°C	14-Lead PDIP	N-14
OP467GS	-40°C to +85°C	16-Lead SOIC_W	RW-16
OP467GS-REEL	-40°C to +85°C	16-Lead SOIC_W	RW-16
OP467GSZ	-40°C to +85°C	16-Lead SOIC_W	RW-16
OP467GSZ-REEL	-40°C to +85°C	16-Lead SOIC_W	RW-16
OP467ARC/883C	−55°C to +125°C	20-Terminal LCC	E-20-1
OP467AY/883C	−55°C to +125°C	14-Lead CERDIP	Q-14
OP467GBC		Die	

¹ Z = RoHS Compliant Part.



022106-A

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<u>5962-9325801M2A OP467AY/883C OP467GS OP467GPZ OP467GSZ 5962-9325801MCA OP467ARC/883C OP467GS-REEL OP467GSZ-REEL</u>